

Docket No.: 3811-0122P

(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:

Yi LYU et al.

Application No.: 10/621,380

Confirmation No.: 4059

Commination No., 405

Filed: July 18, 2003

Art Unit: 1712

For: SILOXANE-BASED RESIN AND

METHOD FOR FORMING INSULATING FILM BETWEEN INTERCONNECT LAYERS IN SEMICONDUCTOR DEVICES BY USING THE SAME Examiner: M. G. Moore

AMENDMENT AFTER FINAL ACTION (37 C.F.R. SECTION 1.116)

MS AF Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

INTRODUCTORY COMMENTS

In response to the Office Action dated May 2, 2005, finally rejecting claims 1 and 3-13, please amend the above-identified U.S. patent application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks begin on page 7 of this paper.